SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines Directly
- Encodes 8 Data Lines to 3-Line Binary (Octal)
- Applications Include:

   N-Bit Encoding
   Code Converters and Generators
- Typical Data Delay . . . 15 ns
- Typical Power Dissipation . . . 60 mW

#### description

These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The 'LS348 circuits encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input E1 and enable output E0) has been provided to allow octal expansion. Outputs A0, A1, and A2 are implemented in three-state logic for easy expansion up to 64 lines without the need for external circuitry. See Typical Application Data.

#### **FUNCTION TABLE**

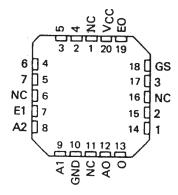
	INPUTS									Ol	JTPU	TS	
EI	0	1	2	3	4	5	6	7	A2	A1	A0	GS	EO
Н	Х	Х	Χ	Х	Χ	X	X	Х	Z	Z	Z	Н	Н
L	Н	Н	Н	Н	Н	Н	Н	Н	z	Z	Z	н	L
L	Х	Χ	Х	Х	Х	Χ	Х	L	L	L	L	L	н
L	Х	Х	Χ	Х	Х	Х	L	Н	L	L	Н	L	н
L	Х	Х	Χ	Χ	Х	L	Н	Н	L	Н	L	L	н
L	Х	Х	Χ	Х	L	Н	Н	Н	L	Н	Н	L	н
L	Ý	Х	Х	L	Н	Н	Н	Н	н	L	L	L	н
L	Х	Х	L	Н	Н	Н	Н	Н	н	L	Н	L	н
L	X	L	Н	H	Н	Н	Н	Н	н	Н	L	L	н
L	L	Н	Н	Н	H	Н	Н	Н	Н	Н	Н	L	н

H = high logic level, L = low logic level, X = irrelevant

SN54LS348 . . . J OR W PACKAGE SN74LS348 . . . D OR N PACKAGE (TOP VIEW)

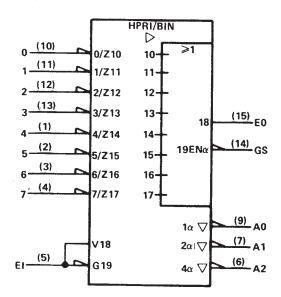
4 🛮 1	U16 VCC
5 🗆 2	15 EO
6 □3	14 🛮 GS
7 🛮 4	13 3
E1 ∏5	12 2
A2 []6	11 🛮 1
- A1 □7	10 🛮 0
GND 8	9 🗌 AO

# SN54LS348 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

# logic symbol<sup>†</sup>



<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

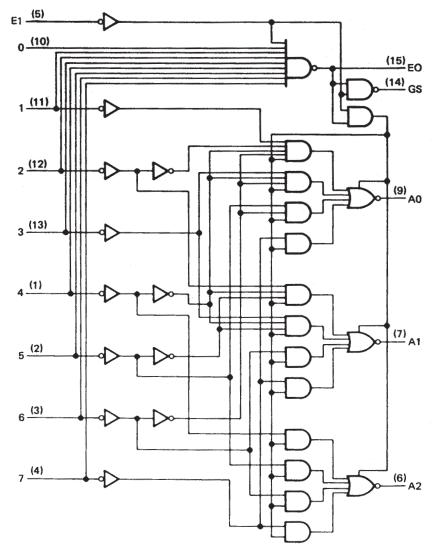
Pin numbers shown are for D, J, N, and W packages.



Z = high-impedance state

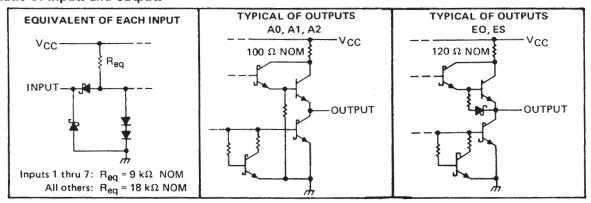
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#### logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

### schematic of inputs and outputs





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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Operating free-air temperature range	SN54LS348
	SN74LS348
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

		SN54LS348			SN74LS348			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5,25	V
High-level output current, IOH	A0, A1, A2			-1			-2.6	mA
migriever output current, 10H	EO, GS			-400			NOM MAX 5 5.25 2.6 400 24	μА
Low-level output current, IOI	A0, A1, A2			12			24	mA
Fow-level on that corrests 10F	EO, GS			4	MIN NOM MAX 5 4.75 5 5.25 1 -2.6 0 -400 2 2 24 4 8	mA		
Operating free-air temperature, TA		-55		125	0		70	°c

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			154LS3	48	SN74LS348			
	TARAMETER	TEST CONDITIONS:			TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIH	High-level input voltage			2			2			V	
VIL	Low-level input voltage				**	0.7			0.8	V	
ViK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>1</sub> = -18 mA			-1.5			-1.5	V	
	High-level	A0, A1, A2	V <sub>CC</sub> = MIN,	I <sub>OH</sub> = -1 mA	2.4	3.1					
VOH T	output voltage	A0, A1, A2	V <sub>!H</sub> = 2 V,	I <sub>OH</sub> = -2.6 mA				2.4	3,1		V
	output voltage	EO, GS	VIL = VILmax	$I_{OH} = -400 \mu A$	2.5	3.4		2.7	3.4		
Low-level VOL 0		A0, A1, A2	V <sub>CC</sub> = MIN,	I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	V
	Low-level	A0, A1, A2	V <sub>IH</sub> = 2 V,	OL = 24 mA					0,35	0.5	
*OL	Output voltage	EO, GS		<sup>1</sup> OL = 4 mA		0.25	0.4		0.25	0.4	
		20, 03	VIL = VILmax	I <sub>OL</sub> = 8 mA					0.35	0.5	
loz	Off-State (high-impedance	A0, A1, A2	V <sub>CC</sub> = MAX,	V <sub>O</sub> = 2.7 V			20		******	20	
.02	state) output current	A0, A1, A2	V <sub>IH</sub> = 2 V	V <sub>O</sub> = 0.4 V			-20			-20	μΑ
l <sub>1</sub>	Input current at maximum	Inputs 1 thru 7	V <sub>CC</sub> = MAX,	V 7.V			0.2			0,2	
'1	input voltage	All other inputs	VCC = MAX,	V   = / V			0.1			0.1	mA
Ιн	High-level input current	Inputs 1 thru 7	V MAAY	V - 22V			40			40	
'1H	riigitiever input current	All other inputs	V <sub>CC</sub> = MAX,	V = 2.7 V	20		20	20		20	μΑ
1	Low-level input current	Inputs 1 thru 7	V 144.V				-0.8			-0.8	
'1L	Low-level hiput current	All other inputs	V <sub>CC</sub> = MAX,	V   = 0.4 V			-0.4			-0.4	mA
loo	Shart sirouit outsut 5	Outputs A0, A1, A2	.,		-30		-130	-30		-130	<u> </u>
.02	onorconcuit output currents	Outputs EO, GS	V <sub>CC</sub> = MAX		-20		-100	-20		-100	mA
Icc	Supply current		V <sub>CC</sub> = MAX,	Condition 1		13	25		13	25	
.00	In Low-level input current  In Short-circuit output current  In Supply current		See Note 2	Condition 2		12	23		12	23	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC (condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open. ICC (condition 2) is measured with all inputs and outputs open.



<sup>\$</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ} \text{ C}$ .

<sup>§</sup>Not more than one output should be shorted at a time.

# SN54LS348, SN74LS348 (TIM9908) 8-LINE TO 3-LINE PRIORITY ENCODERS **WITH 3-STATE OUTPUTS**

SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

PARAMETER <sup>†</sup>	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ФLН	1 thru 7	A0, A1, or A2	In-phase		111	11	17	ns
tPHL.	1 11114 /	A0, A1, 01 A2	output	C. = 45 = 5		20	30	113
ФLН	1 thru 7	AO A1 as A2	Out-of-phase	CL = 45 pF,		23	35	ns
<b>tPHL</b>	i thru /	AU, A1, 01 A2	A0, A1, or A2 Output $R_L = 667 \Omega$ , See Note 3			23	35	113
<b>tPZH</b>	EI	A0, A1, or A2		See Note 3		25	39	ns
ΨZL	] '	70, 71, 01 72				24	41	] ""
<b>tPLH</b>	Othru 7	0 thru 7 EO Out-of-phase			11	18	ns	
<b>tPHL</b>	O and /	20	output			26	40	
<b>tPLH</b>	0 thru 7	GS	In-phase	Cլ = 15 pF		38	55	ns
tPHL	O and /		output	$R_{\perp} = 2 k\Omega$ ,		9	21	
<b>tPLH</b>	EI	GS	In-phase		11		17	
<b>tPHL</b>	1 -	EI GS output  EI EO In-phase output			14	36	ns	
ФLН	EI					17	26	
tPHL	1 "			:		25	40	ns
tPHZ	EI	A0, A1, or A2		CL = 5 pF		18	27	
ヤLZ	] -'	70, 71, 01 72		R <sub>L</sub> = 667 Ω		23	35	ns

<sup>†</sup> tpLH = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

# TYPICAL APPLICATION DATA

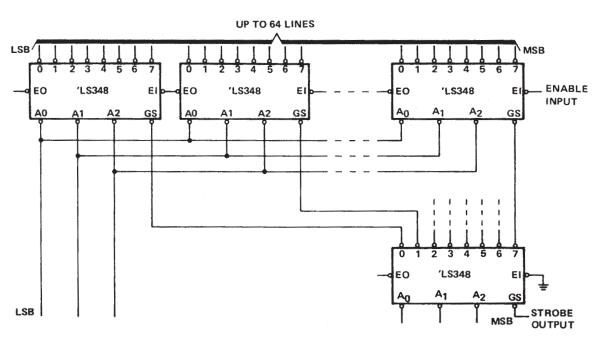


FIGURE 1-PRIORITY ENCODER WITH UP TO 64 INPUTS.



tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level

www.ti.com 11-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/	MSL rating/ Op temp (°C) Peak reflow	
	(1)	(2)			(3)	(4)	(5)		(6)
SN74LS348D	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS348
SN74LS348D.A	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS348
SN74LS348N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS348N
SN74LS348N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS348N

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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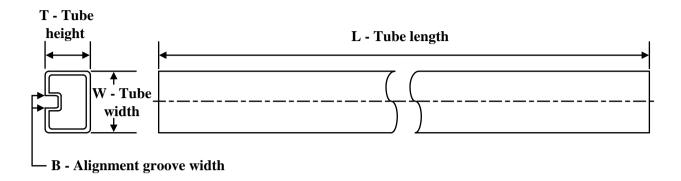
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



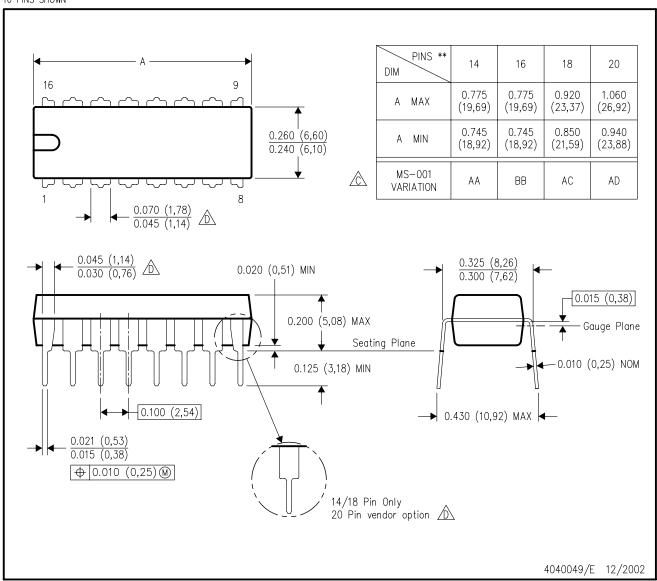
\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74LS348D	D	SOIC	16	40	507	8	3940	4.32
SN74LS348D.A	D	SOIC	16	40	507	8	3940	4.32
SN74LS348N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS348N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS348N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS348N.A	N	PDIP	16	25	506	13.97	11230	4.32

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



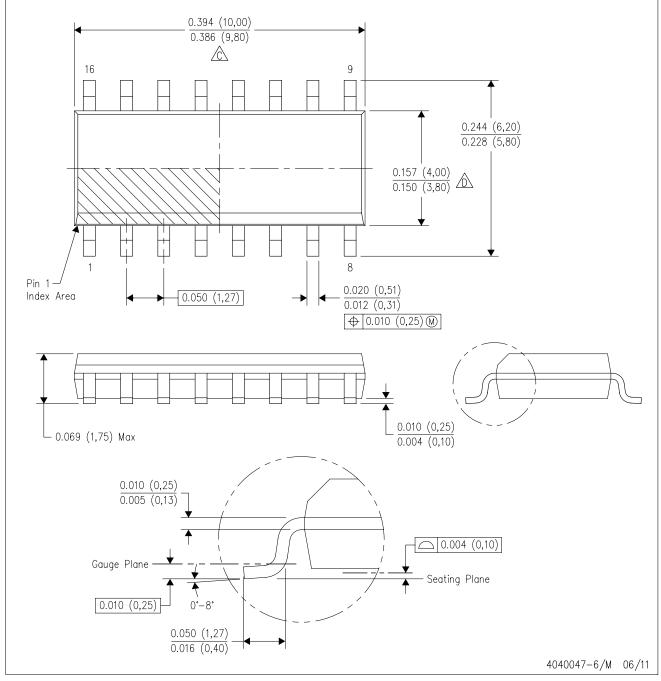
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDS0-G16)

# PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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Last updated 10/2025